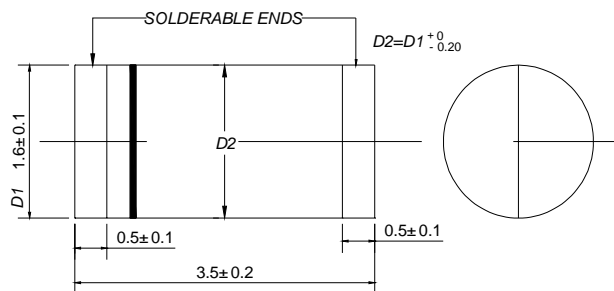




Features

Plastic package has underwriters laboratories
flammability classification 94V-0
Glass passivated chip junction
For surface mount applications
High temperature metallurgically bonded construction
Cavity-free glass passivated junction
High temperature soldering guaranteed:450 /5 seconds
at terminals.Complete device sub-mersible temperature
of 265 for 10 seconds in solder bath

DO - 213AA



Mechanical Data

Case: JEDEC DO-213AA,molded plastic
Polarity: Color band denotes cathode
Weight: 0.0014 ounces, 0.036 grams
Mounting position: Any

Dimensions in millimeters

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25 ambient temperature unless otherwise specified.

Single phase,half wave,60 Hz,resistive or inductive load. For capacitive load,derate current by 20%.

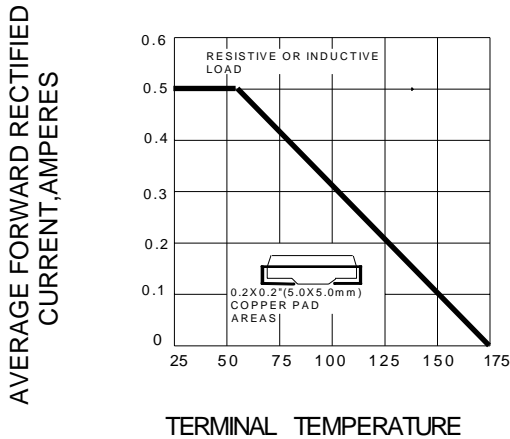
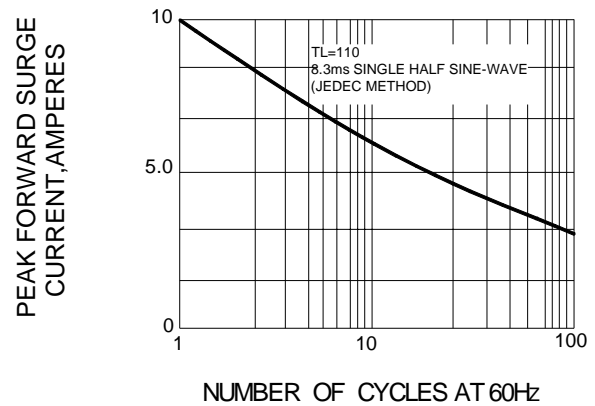
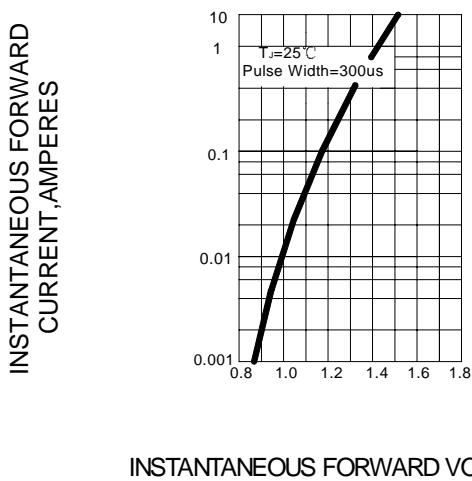
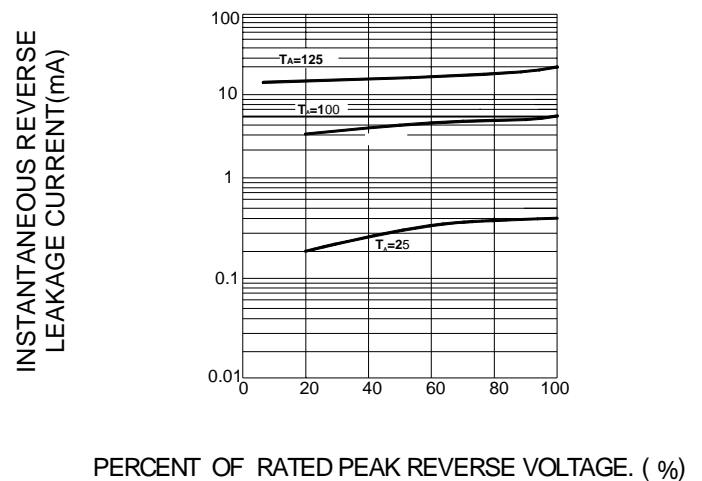
		RGL 34A	RGL 34B	RGL 34D	RGL 34G	RGL 34J	RGL 34K	RGL 34M	UNITS
Maximum recurrent peak reverse voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current T _T =55	I _(AV)	0.5							A
Peak forward surge current 8.3ms single half-sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	10							A
Maximum instantaneous forward voltage @0.5A	V _F	1.3							V
Maximum reverse current @T _A =25 at rated DC blocking voltage @T _A =125	I _R	5.0 50							μA
Maximum reverse recovery time (Note 1)	t _{rr}	150				250	500		ns
Typical junction capacitance (Note 2)	C _j	4.0							pF
Typical thermal resistance (Note 3)	R _{θJA}	150							/W
Operating junction temperature range	T _j	- 55 ---- +175							
Storage temperature range	T _{STG}	- 55 ---- +175							

NOTE: 1. Measured with $I_F=0.5A, I_R=1.0A, I_T=0.25A$

2. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.

3. Thermal resistance from junction to ambient, 0.24x0.24"(6.0x6.0mm) copper pads to each terminal.

Ratings AND Characteristic Curves

FIG.1 – FORWARD CURRENT DERATING CURVE

FIG.2 – MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

FIG.3 – TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

FIG.4 – TYPICAL REVERSE CHARACTERISTICS

FIG.5 – REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM
